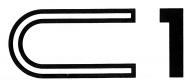
MUSIC COMPUTER



SERVICE MANUAL



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IMPORTANT NOTICE

This manual has been provided for the use of authorized Yamaha Retailers and their service personnel. It has been assumed that basic service procedures inherent to the industry, and more specifically Yamaha Products, are already known and understood by the users, and have therefore not been restated.

WARNING:

Failure to follow appropriate service and safety procedures when servicing this product may result in personal injury, destruction of expensive components and failure of the product to perform as specified. For these reasons, we advice all Yamaha product owners that all service required should be performed by an authorized Yamaha Retailer or the appointed service representative.

IMPORTANT: The presentation or sale of this manual to any individual or firm does not constitute authorization, certification, recognition of any applicable technical capabilities, or establish a principle-agent relationship of any form.

The data provided is believed to be accurate and aplicable to the unit(s) indicated on the cover. The research, engineering, and service departments of Yamaha are continually striving to improve Yamaha products. Modifications are, therefore, inevitable and changes in specification are subject to change without notice or obligation to retrofit. Should any discrepancy appear to exist, please contact the distributor's Service Division.

WARNING:

Static discharges can destroy expensive components. Discharge any static electricity your body may have accumulated by grounding yourself to the ground buss in the unit (heavy gauge black wires connect to this buss).

IMPORTANT: Turn the unit OFF during disassembly and parts replacement. Recheck all work before you apply power to the unit.

■ SPECIFICATIONS

CPU:

80286 (switchable clock 10/8

MHz)

RAM:

640K bytes main, 512K bytes

extension

ROM: Disk:

64K bytes FDD model:

2 x 3.5" 2DD floppy disk

HDD model:

1 x 3.5" 2DD floppy disk 1 x 3.5" 20M byte hard disk

Display: VRAM:

640 x 400 dot backlit LCD

64K bytes

External Display

Output:

Digital RGB,

Video (Monochrome Display

mode)

Interface:

1 x Printer (Centronics) 2 x Serial (RS232C)

2 x MIDI IN

8 x MIDI OUT 1 x MIDI THRU

Time Code In, Time Code Out.

Expansion Card Slot

Dimensions:

394 (W) x 382 (D) x 82

(H) mm

(15-1/2" x 15" x 3-1/4")

Weight:

FDD model:

8.2 kg (18 lb 2 oz)

HDD model:

120V 60Hz

8.5 kg (18 lb 12 oz)

Power Requirements: Power Consumption:

120V/0.6A Max.

AC Outlet:

132V/1A Max.

Backup Battery:

Ni-Cd

Included Items:

Power cable, 2 x 3.5" disk

(MS-DOS 3.3, MIDI Monitor and Bulk Manager), Operating manual

MS-DOS is a registered trademark of Microsoft Corporation.

IBM is a registered trademark of International Bu-

siness Machines Corporation.

■ PRODUCT SUMMARY

The Yamaha C1 is a lap top computer designed for music applications. The C1 computer contains a built-in 640 x 400 dot Liquid Crystal Display (LCD) unit. While the C1 computer specification also provides for an optional hard disk drive, the most common C1 configuration contains two 3.5-inch double sided, double density floppy disk drives. The C1 computer provides hardware interfaces, and software programs for MIDI control and SMPTE time code management.

■ BASIC FUNCTIONS AND FEATURES

Since the C1 is a self-contained computer with two floppy disk drives and a panel display, the computer only requires a system DOS boot-up disk to be inserted into the (A) upper disk drive. Also, the display configuration switch (SW1) on the rear panel must be in the LCD (up) position. After power-on, the display will come on with the following messages:

Date: Time: A >

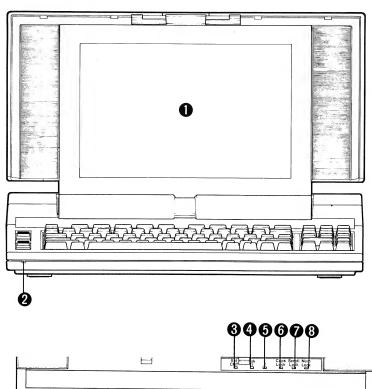
The date and time inputs can be by-passed by pressing the "Enter" key on the computer keyboard. (A>) is a DOS prompt indicating you must enter a legitimate DOS command at this point, or the command can be the name of an operating program which resides in drive (A). Also, the prompt indicates the computer will use the (A) drive to retrieve subsequent files unless the operator changes the DOS prompt.

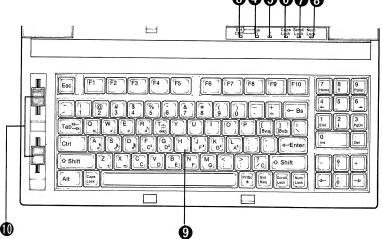
Features:

- The C1 is operated by an 80286 micro-processor operating at 10 MHz.
- 640K bytes basic memory plus 512K bytes extended memory for a total of 1.152M bytes of working memory.
- The C1 contains two 3.5-inch floppy disk drives. The floppy disks are double sided, double density providing approximately 720K bytes each.
- The display controller is a Yamaha V6366 Panel or CRT Display Controller (PCDC). Using the PCDC, display
 modes compatible with the IBM Color Graphics monitor Adapter (CGA) and the Hercules Graphic Card
 (HGC) are supported.
- A 640 x 400 dot LCD with an electroluminescent (EL) backlight is the built-in display device. The display is automatically turned on/off by opening/closing the LCD panel. An external CRT display can also be used. The internal LCD can only display in CGA mode. When using the CGA mode, the display can also be switched to the external CRT display. HGC mode can only be displayed on the external CRT display.
- A Ni-Cad battery pack provides approximately 600 hours of computer operation after 48 hours of charging.
- An 88-key keyboard with numeric key pad.
- 2 serial RS232C ports
 1 parallel printer (Centronics) port
- For music application the following are provided:

MIDI IN — 2 channels
MIDI OUT — 8 channels
MIDI THRU — 1 channel
SMPTE Time Code interface IN/OUT
2 analog sliders
2 application timers

■ PARTS AND CONTROLS





1 LCD Display:

Backlit 640 x 400 dot Liquid Crystal Display. When this display screen is folded down, the backlight is automatically turned off. The left side panel has controls for LCD contrast and backlight brightness.

2 Power LED:

This LED lights when the C1's power is turned on.

3 Use External CRT:

This LED indicates that an external display is being used instead of the C1's built-in LCD screen.

4 Disk in Use Upper Drive:

This LED lights red to indicate that the floppy disk in drive A is being accessed. *Do not remove the floppy disk or turn the power off while this LED is on.*

6 Disk in Use Lower Drive:

This LED lights red to indicate that the floppy disk in drive B (or the hard disk in drive C for hard disk models) is being accessed. For the hard disk model, this LED lights green to indicate that the read/write head is unparked. (The hard disk read/write head automatically parks itself to a safe position when there has been no disk access for 5 seconds.) Do not remove the floppy disk or turn the power off while this LED is on.

6 Caps Lock LED:

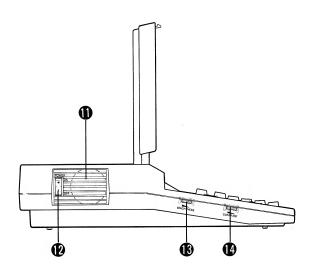
The "Caps Lock" key toggles this LED on/off. When this LED is on and the Shift key is released, alphabet keys A-Z will produce uppercase letters. When the Shift key is pressed, lowercase letters will be produced.

7 Scroll Lock LED:

The "Scroll Lock" key toggles this LED on/off. The effect will be determined by the application program.

(8) Num Lock LED:

The "Num Lock" key toggles this LED on/off. When it is on, the numeric key pad at the right



Vent:

To prevent overheating, do not obstruct the cooling fan vent.

Power Switch:

Push this switch up to turn the power on. Push down to turn the power off.

B Backlight Brightness Control:

Rotate this control towards you to darken the backlight.

LCD Contrast Control:

Rotate this control towards you to decrease the contrast of the LCD. Adjust it to suit your

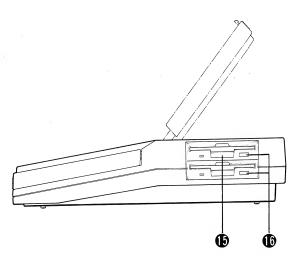
side of the alphabet keys can be used to enter numbers 1-9. When it is off, the numeric key pad will act as the cursor (arrow) and other function keys.

Keyboard:

A standard 88-key ASCII keyboard. The effect of the function keys and control keys will be determined by the application program.

(1) Control Sliders 1,2:

These general purpose sliders function as determined by the application program (the MIDI Monitor program, etc.).



viewing angle. Extreme settings of this control will make the LCD screen appear blank.

(b) 3.5" Floppy Disk Drive:

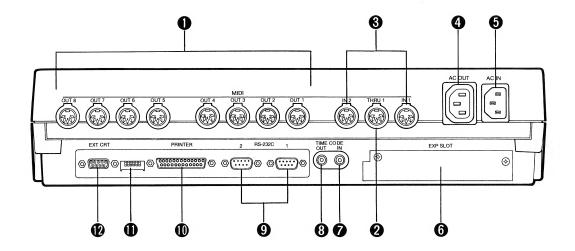
The C1 has two 3.5" 720K byte floppy disk drives.

3.5" Hard Disk Drive (HDD model):

The hard disk model of the C1 has a 3.5" non-removable hard disk instead of the lower floppy disk drive.

(f) Floppy Disk Eject Button:

Press this button to eject the floppy disk.



1 MIDI OUT:

The C1 can transmit MIDI messages from these terminals.

2 MIDI THRU:

MIDI messages received at MIDI IN 1 are retransmitted unchanged from this terminal.

MIDI IN:

The C1 can receive MIDI messages at these terminals.

4 AC Out:

This AC outlet is powered when the C1's power is on. When using an external display screen (IBM Monochrome Display), connect its AC cable to this outlet. Some displays may be damaged if powered on without an incoming video signal. Using this AC outlet for the display ensures that the display is not turned on unless the C1's power is on.

6 AC IN:

Connect this terminal to an AC outlet using the included power cable.

6 Expansion Slot:

Optional cards such as extended memory can be plugged into this slot.

7 TIME CODE IN:

The C1 can receive time code from a tape recorder line output connected to this terminal. (Use a pin plug cable.)

TIME CODE OUT:

The C1 can transmit time code from this terminal to a tape recorder line input connected to this terminal. (Use a pin plug cable.)

9 RS232C:

These are standard connectors for attaching a serial mouse or a modem.

(1) PRINTER:

A Centronics-type printer can be connected to this terminal.

DIP Switches:

These six switches determine system settings and display modes.

(P) CRT:

An IBM PC Color Graphic Display (CGA mode) or IBM PC Monochrome Display (Hercules graphics card compatible mode) can be connected to this terminal.

■ SYSTEM BLOCK DIAGRAM

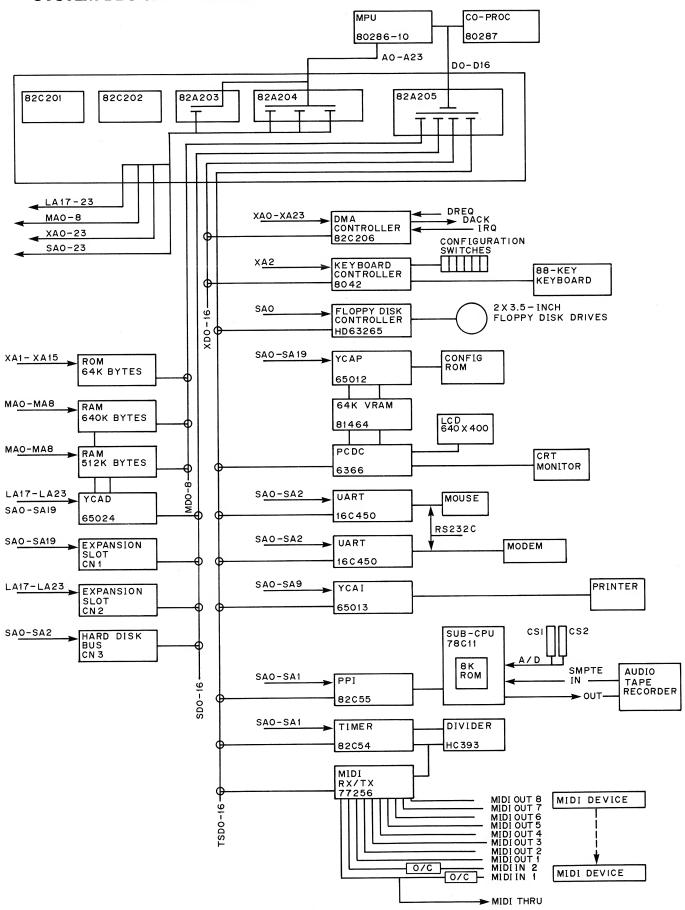


Fig. A - C1 Block Diagram

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CJ

In Figure A it is apparent that all devices are isolated from the Main Processor Unit (MPU) 80286 by buffers in the LSI's 201, 202, 203, 204, and 205. The Co-Processor (80287) is optional for those applications which are math intensive.

While the MPU requires only one data bus for all I/O transfers, the C1 provides four Data Bus systems for the entire unit. The Address Bus is also expanded to four Address systems from a single MPU address bus. This arrangement allows Direct Memory Access (DMA) within the C1 computer. DMA transfer is only possible between memory systems, i.e., a floppy transfer to RAM would be an example of a DMA transfer. A more specific example of DMA transfer would be: the MPU would latch a source address, the MPU then latches a destination address, the data buffer 82A205 (data bus) would be configured to connect the data source to the data destination, and then the bus control signals would be asserted to cause the data to be latched into the RAM location. Notice, data does not pass through the MPU as it would in a normal MPU operation; hence, the time required for a DMA transfer is much less than a normal data transfer. This characteristic is very desirable where operations require many bytes of transfer from disk to system RAM memory. Another reason for multiple bus systems in the C1 is, the MPU is operating at 10 MHz high data rates; in this environment, the number of devices allowed on any bus (Address or Data) are limited by the speed requirements of the MPU.

DMA Controller 82A206

The accessory IC's which support the MPU will accumulate and identify or distribute the individual signals necessary to interface every device in the system. The DMA controller sums all processor interface signals and distributes the acknowledge signals (ACK) from the MPU. Direct Memory Access Request, (DREQ) is a request for a direct data connection from Disk to RAM. "DACK" is interpreted as permission from the MPU for a DMA transfer, or the OK for such a transfer from the Main Processor Unit. All other devices in C1 computer interface with the MPU through Interrupt (IRQ) signals, and the subsequent chip selects the MPU issues in response to the IRQ's.

Keyboard Controller 8042

The 8042 is an Universal Peripheral Interface Controller with 2K bytes of ROM and 64 bytes of RAM. The Keyboard controller provides two functions: at power-on the controller inputs the system configuration from 6 DIP switches on the rear panel of the unit, OR normally the controller is encoding the 88-key keyboard before that data is input to the MPU.

The configuration switches determine what the system configuration is to be. The switches indicate:

- 1. Liquid Crystal Display / Cathode Ray Tube
- 2. IBM Color Graphics Adapter / Hercules Graphic Card
- 3. C1 external I/O enable / disable
- 4. SIO Internal / External
- 5. 512K bytes expanded memory ENABLE / DISABLE
- 6. CPU clock 10 MHz / 8 MHz operation

There are a second set of switches on the Main board which are in addition to the previous mentioned switches. DIP switch 2 indicates:

- FDD-Selects the floppy disk or the Hard disk model.
 - on = Floppy Disk Model
 - off = Hard Disk Model
- 2. HDD-Selects the floppy disk or the Hard disk model.
 - on = Hard Disk Model
 - off = Floppy Disk Model
- 3. Bit 6 of the system configuration information. For the C1, set to off (high level).
- 4. Bit 7 of the system configuration information. For the C1, set to off (high level).

In the scan mode, the 8042 develops a scanner output and a scanner input system. From the multiplexed scanner data, the 8042 encodes KEY-MAKE and KEY-BREAK data which is sent to the Main Processor Unit. Each key has a unique MAKE number and a unique BREAK number.

Examples:

key number	make code	break code
1	01	81
2	02	82
3	03	83
4	04	84
5	05	85
6	06	86
10	0A	8A

Floppy Disk Controller HD63265

The floppy disk controller interfaces with the Main Processor Unit with the conventional IRQ and the Direct Memory Access. Direct Memory Access is made through the DMA controller 82C206. The unit will usually be configured with two floppy disks: however, the Hard Disk is an optional memory device in the C1 computer.

YCAP-VRAM-PCDC

YCAP (IC24) is a helping processor controller for PCDC. Initially YCAP loads Video RAM (VRAM) with the initial LCD display messages and it places an operating program for PCDC in the video RAM. Beyond the power-up initialization, YCAP provides addressing control (A0-A15) over VRAM during data load operations from the MPU, while data (TSD0-TSD7) arrives via PCDC (IC25).

VRAM (IC's 60, 61) contains 64K bytes of control program and display data for PCDC. Control data is placed here by the YCAP chip, while display data is placed here by the MPU. In the initial power-up configuration mode, YCAP controls the Address and the Data bus; however, in the video output mode, PCDC controls the VRAM Address bus in order to read the display data. Immediately after power-on, PCDC (IC25) is configured to either provide an LCD or CRT display by the MPU. Configuration switch 1 should be in the "up" position for the LCD display. LCD control voltage is inhibited until approximately 100 control registers in the PCDC are loaded with control data, this precaution prevents DC voltage from being placed on the display before the video program is ready to run. If a DC condition is allowed to exist during this time, chemical alteration of the crystal display may occur, adversely affecting the panel display life.

USART 16C450

The UARTS provides a high speed Serial to Parallel or Parallel to Serial interface to/from the MPU. The external connections are configured to the RS232C serial interface. Transmission and Reception are asynchronous, which means the data transmitted and received must operate the receivers without benefit of strobes or clocks, there are no additional word measuring signals. RS232C Data format is usually 8 bits, while start and stop bits are added to operate the receivers. RS232C data format provides for transmission rates up to 20 KHz.

YCAI 65013

YCAI is a general purpose IC, but one of the main functions that it provides is the parallel printer interface. The printer interface is mainly an output port, the controller monitors the printer "BUSY" line to determine when to send more characters. The remaining functions in YCAI are chip select decode for the various peripheral devices.

Sub-CPU 78C11

The 78C11 provides: Society of Motion Pictures and Television Engineers (SMPTE) code Receiver and Transmitter functions, also A to D conversion function for the front panel continuous slider inputs. The 78C11 contains an 8K byte ROM operating program, therefore, it requires no instructions from the MPU to be able to perform this function. The Sub-CPU to MPU interface is performed using Interrupt and chip selects.

SMPTE code format is 80 bits per frame, while the information contained in the 80 bits is: Hours, Minutes, Seconds, and Frame count. Hours, minutes, seconds, and frames are each encoded with two BCD bytes. SMPTE time code can be subsequently converted into MIDI TIME CODE (MTC) by the MPU. SMPTE code is electrically encoded using Manchester Bi-Phase Mark code. There are four frame rates used with SMPTE time code:

- 1. 24 frames per second
- 2. 25 frames per second
- 3. 29.97 frames per second or drop frame (color TV)
- 4. 30 frames per second (TV)

The multiple frame rates are provided for by the sub-CPU.

PPI 82C55

The 82C55 is a three port communication device through which the MPU can send or receive data via (TSD0-TSD7) the system data bus.

Timer 82C54

The Timer provides two programmable timer functions which are assigned by the operator. The MPU enters numbers to the timer registers via the data bus. The timer outputs cause Interrupts at the MPU via the YCAI chip.

MIDI 77256

The MIDI chip is a proprietary MIDI interface device which can provide 10 simultaneous serial communication ports. The MIDI chip provides 2 MIDI inputs and 8 MIDI outputs.

MIDI data format is 8 bits serial; however, each byte also includes a negative start pulse and a positive stop pulse. The start pulse causes the receiver to strobe the input data line for 10 data periods. The stop pulse signals the end of a complete data word. Data transmission and reception are asynchronous. "Asynchronous" means, there are no additional signals transmitted to aid the receiver in word measure. The receiver must trigger on the start bit and strobe the data line for 10 data periods to receive a data byte. The transmitter portion of the MIDI chip attaches the start and stop bits to the transmitted data byte.

ROM 64K bytes

The system operating programs reside in ROM. The MPU retrieves system programs through the Address and Data buffers 82A204 and 82A205 respectively.

RAM 640K bytes

The system operating RAM is the location where all system variables are placed. Floppy and Hard disk operating programs are also placed here. This device is capable of DMA transfers to and from the disk drives.

RAM 512K bytes

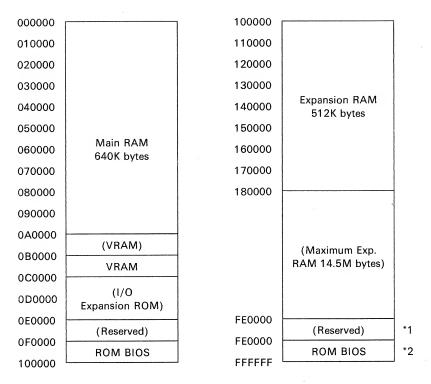
Extended RAM memory for the operating system. Disk is used to save or load data to/from the main work area of memory.

YCAD 65024

YCAD is a general purpose IC, the most important function that it provides is the memory decode function.

Hard Disk Bus

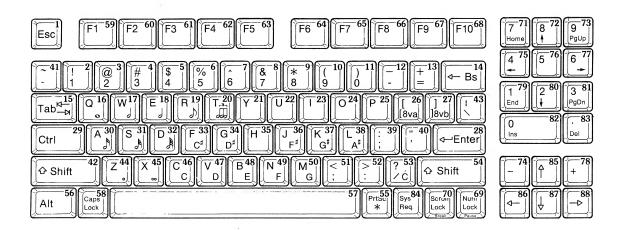
The C1 computer provides for an optional 20M bytes hard disk drive unit.



NOTE:

- *1 Duplicate of 0E0000 to 0EFFFF
- *2 Duplicate of 0F0000 to 0FFFFF
- () is not installed in the C1.

Fig. B — Memory Map



 ${\bf Fig.} \ {\bf C-Keyboard\ Locator\ Numbers}$

I/O Port (Hex)	Device/Function
000-01F	DMA Controller 1, 8237A-5 equivalent
020-03F	Interrupt Controller 1, 8259A equivalent
040-05F	Timer, 8254-2 equivalent
060-06F	Keyboard Controller
070-07F	Real Time Clock, NMI (Non-Maskable Interrupt) Mask
080-09F	DMA Page Register, 74LS612 equivalent
0A0-0BF	Interrupt Controller 2, 8237A-5 equivalent
0C0-0DF	DMA Controller 2, 8237A-5 equivalent
0E0-0EF	Reserved
0F0	(Clear Math Coprocessor Busy)
0F1	(Reset Math Coprocessor)
0F8-0FF	(Math Coprocessor)
100-1EF	Reserved
1F0-1F8	Fixed Disk Controller *1
200-207	(Game I/O)
278-27F	(Parallel Printer Port 2)
2F8-2FF	Serial Port 2
300-31F	C1 Expansion I/O
360-36F	Reserved
378-37F	Parallel Printer Port 1
380-38F	(SDLC, Bisynchronous 2)
3A0-34F	(Bisynchronous 1)
3B0-3BF	PCDC HGC Mode
3C0-3CF	Reserved
3D0-3DF	PCDC CGA Mode
3F0-3F7	Floppy Disk Controller
3F8-3FF	Serial Port 1

NOTE:

- *1 Not installed in the FDD model.
 *2 () is not installed in the C1.

 ${\rm Fig.}~{\rm D-I/O}~{\rm Address}~{\rm Map}$

■ POST (POWER-ON SELF TEST)

The C1 BIOS ROM contains the program for self-diagnosis of the main components of the system. This test is executed automatically when power is turned on, and the results are displayed as a POST message on the LCD.

There are two types of POST messages as follows:

- Error messages indicate a failure with either the hardware, software, or firmware.
- Informational messages provide important information about the power-on and boot processes.

The error and informational messages for POST are listed separately below.

POST Error Messages

The table below gives possible causes and solutions for the POST error messages.

NOTE: Italicized items within the message text will be replaced by the appropriate value when the message is issued.

Table 1 — POST Error Messages

MESSAGE	POSSIBLE CAUSE	SOLUTION
Diskette drive 0 seek to track 0 failed	The A: drive has either failed or is missing.	Check the A: drive.
Diskette drive reset failed	The diskette adapter has failed.	Check the diskette adapter.
Diskette read failure — strike F1 to retry boot	The diskette is either not formatted or defective.	Replace the diskette with a bootable diskette and retry boot.
Display adapter failed; using alter- nate	The color/monochrome switch is set wrong.The primary video adapter failed.	Change the switch to the correct setting.Check the primary video adapter.
Gate A20 failure	Protected mode cannot be enabled.	Most likely, the problem is with the system board check the system board.
Hard disk controller failure	The controller card has failed.	Replace the controller card.
Hard disk failure	<u> </u>	Retry boot. If that doesn't work, replace the hard disk.
Hard disk read failure — strike F1 to retry boot	The working diskette or the hard disk is defective.	Retry boot. If that doesn't work, replace the diskette.
Invalid configuration information — please run SETUP program	 Memory size is configured wrong. Display adapter is configured wrong. Wrong number of diskette drives. 	Run the SETUP utility program.
Keyboard clock line failure	Either the keyboard or the keyboard	Make sure the keyboard cable is
Keyboard data line failure	cable connection is defective.	connected properly.
Keyboard controller failure	The keyboard controller firmware has failed.	Check the keyboard controller.
Keyboard is locked — please unlock	The keyboard lock located at the front of the computer is activated.	
Keyboard stuck key failure	A key(s) is jammed.	Try pressing the key(s) again.
Memory address line failure at hex-value, read hex-value expecting hex-value	Circuitry associated with the memory chips has failed.	Check the circuitry.

Table 1 - POST Error Messages (Continued)

MESSAGE	POSSIBLE CAUSE	SOLUTION
Memory data line failure at hex-value, read hex-value-hex-value	One of the memory chips or associated circuitry has failed.	Try replacing the memory chips.
Memory high address line failure at hex-value-hex-value	Circuitry associated with the memory chips has failed.	Check the circuitry.
Memory odd/even logic failure at hex-value, read hex-value expecting hex-value	Circuitry associated with the memory chips has failed.	Check the circuitry.
Memory parity failure at hex-va- lue-hex-value	One of the parity memory chips has failed.	Try replacing the memory chips.
Memory wirte/read failure at hex-value, read hex-value expecting hex-value	One of the memory chips has failed.	Try replacing the memory chips.
No boot device available — strike F1 to retry boot	Either diskette drive A:, the hard disk, or the diskette itself is defective.	Retry boot. If that doesn't work, replace the floppy diskette or the hard disk.
No boot sector on hard disk — strike F1 to retry boot	The C: drive is not formatted.	Format the C: drive.
No timer tick	The timer chip has failed.	Check the timer chip on the system board.
Not a boot diskette- strike F1 to retry boot	The diskette in drive A: is not formatted as a bootable diskette.	Replace the diskette with a bootable diskette and retry boot.
Hex-value Optional ROM bad Checksum = hex-value	The peripheral card contains a defective ROM.	Replace the peripheral card.
Shutdown failure	The keyboard controller or its associated logic has failed.	Check the keyboard controller.
Time-of-day clock stopped	The CMOS Time-of-day clock chip has failed.	Run the SETUP utility.
Timer chip counter 2 failed	_	Check the timer chip system board.
Timer or Interrupt Controller bad	Either the timer chip or the Interrupt Controller is defective.	Check the timer chip or the Interrupt Controller on the system board.
Unexpected interrupt in protected mode	The non-maskable interrupt (NMI) port can't be disabled.	Check the system board, particularly the logic associated with the non-maskable interrupt.

POST Informational Messages

The table below describes the POST informational messages.

NOTE: Italicized items within the text will be replaced by the appropriate value when the message is issued.

Table 2 — POST Informational Messages

MESSAGE	MEANING
Hex-value Base Memory, hex-value Expansion	This message indicates the amount of memory that has tested successfully.
Decreasing available memory	This message immediately follows any memory error message, and informs you that the memory chips are failing.
Memory tests terminated by keystroke	This message indicates that you have pressed the Spacebar while the memory tests were running. This stops the memory tests.
Phoenix 80286 ROM BIOS PLUS Version 3.10 02 Copyright (C) 1985-1988 Phoenix Technologies Ltd. All Rights Reserved	This copyright message is displayed on the initial boot screen and indicates that POST has started.
Strike the F1 key to continue	This message indicates that an error was found during POST. Pressing the F1 key allows the system to attempt to boot.

Run-Time Messages

Run-time messages are displayed if an error occurs after the boot procedure is complete.

The table below gives possible causes and solutions for the run-time messages.

NOTE: Italicized items within the message text will be replaced with the appropriate value when the message is issued.

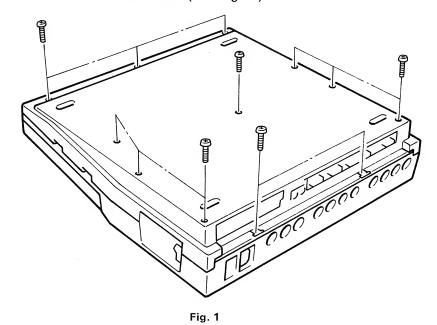
Table 3 — Run-Time Messages

MESSAGE	POSSIBLE CAUSE	SOLUTION
I/O card parity interrupt at address. Type (S)hut off NMI, (R)eboot, other keys to continue	The peripheral card has failed.	Type (S)hut off NMI. Note: This will only temporarily allow you to continue. You must replace the peripheral card.
Memory parity interrupt at address. Type (S)hut off NMI, (R)eboot, other keys to continue	A memory chip(s) has failed.	Type (S)hut off NMI. Note: This will only temporarily allow you to continue. You must replace the memory chip(s).
Unexpected HW interrupt interrupt at address. Type (R)eboot, other keys to continue	This could be any hardware-related problem. Note: This message will not be displayed if INTENHD is false.	Check the hardware.
Unexpected HW interrupt <i>interrupt</i> at <i>address</i> . Type (R)eboot, other keys to continue	There is an error(s) in the software program. Note: This message will not be displayed if INTENHD is false.	Try turning the machine off and then on again. If that doesn't work, check the program.
Unexpected type 02 interrupt at address. Type (S)hut off NMI, (R)eboot, other keys to continue	There is an error(s) in the software program. Note: This message will not be displayed if INTENHD is false.	Try turning the machine off and then on again. If that doesn't work, check the program.

■ DISASSEMBLY PROCEDURES

Upper Case Assembly Removal

- 1. Place the unit upside down.
- 2. Remove the twelve screws from the lower case. (See Fig. 1.)



- 3. Replace the unit in its normal position.
- 4. Gently lift up the upper case assembly, then disconnect the cable that is attached to the upper case assembly.

Keyboard Assembly Removal

- 1. Remove the upper case assembly. (See Upper Case Assembly Removal.)
- 2. Remove the seventeen screws for the shield cover to be removed. (See Fig. 2.)

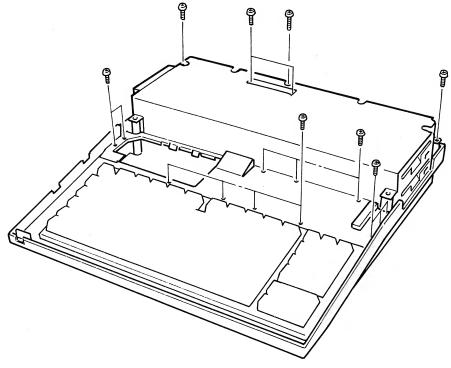


Fig. 2

- 3. Remove the three screws of the shield cover on the left side of the keyboard.
- 4. Gently lift up the keyboard assembly and disconnect the two flexible connector sheets that are attached to the Main circuit board.

Main Circuit Board Removal

- 1. Remove the upper case assembly and the keyboard unit.
- 2. Remove the two screws from the slot cover on the left rear panel.
- 3. Remove the screw as shown in the Fig. 3 and lift out the power supply/FDD/fan assembly, then disconnect four connectors that are attached to the Main circuit board.

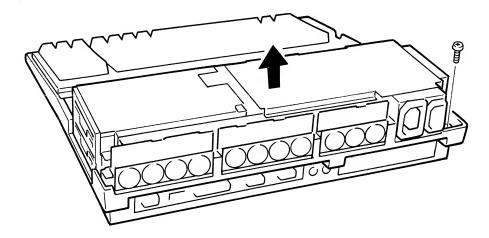


Fig. 3

- 4. Disconnect CN10, CN11 and CN12 connectors from the Main circuit board and remove these three MIDI Connector boards completely.
- 5. Remove the eleven screws for the Main circuit board to be removed.

FDD (Floppy Disk Drive) Unit Removal

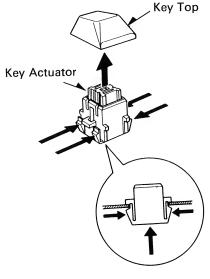
- 1. Remove the upper case assembly and the shield cover mounted over the Main circuit board, then remove the power supply/FDD/fan assembly.
- 2. Remove the eight screws on the two sides of FDD (four for each FDD), then slide upward and lift out the FDD unit very carefully.
- 3. Disconnect the cables which are attached to the FDD unit.

Power Supply Unit Removal

- 1. Remove the upper case assembly and the shield cover mounted over the Main circuit board, then remove the power supply/FDD/fan assembly from the unit.
- 2. Remove the screw (between FDD and Power Supply) to remove the shield cover mounted over the power supply unit.
- 3. Remove the two screws for the cooling fan vent to be removed.
- 4. Remove the two screws for the power switch/AC socket assembly to be removed, then disconnect the cable attached to the power supply unit.
- 5. Remove the five screws for the power supply unit to be removed.

Key Top and Key Actuator Removal

- 1. Remove the keyboard assembly from the unit.
- 2. Each key top can be removed by pulling out. For the key tops with the key guide wire such as the Shift, Ctrl, Space bar and Ins, first remove the wire from its groove then pull out the key top.
- 3. The switch contact plate can be removed from the keyboard assembly by removing the 13 screws.
- 4. Each key actuator can be removed from the keyboard frame by pushing its stopper claws inward. (See Fig. 4.)



LCD Unit and EL Panel Removal

- 1. Open the display panel fully.
- 2. Using a blade-type screwdriver, open the upper part of the display panel. Then pull out the panel toward you until it is completely released. (See Fig. 5.)

Fig. 4

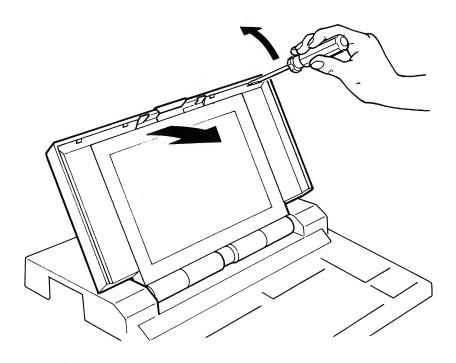


Fig. 5

- 3. Disconnect the cable attached to the upper right side of the LCD unit.
- 4. Remove the four screws securing the LCD unit.
- 5. Remove and hold the LCD unit, then disconnect the flat cable.
- 6. The EL panel can be removed by pulling the connector at the upper right side of the LCD unit.

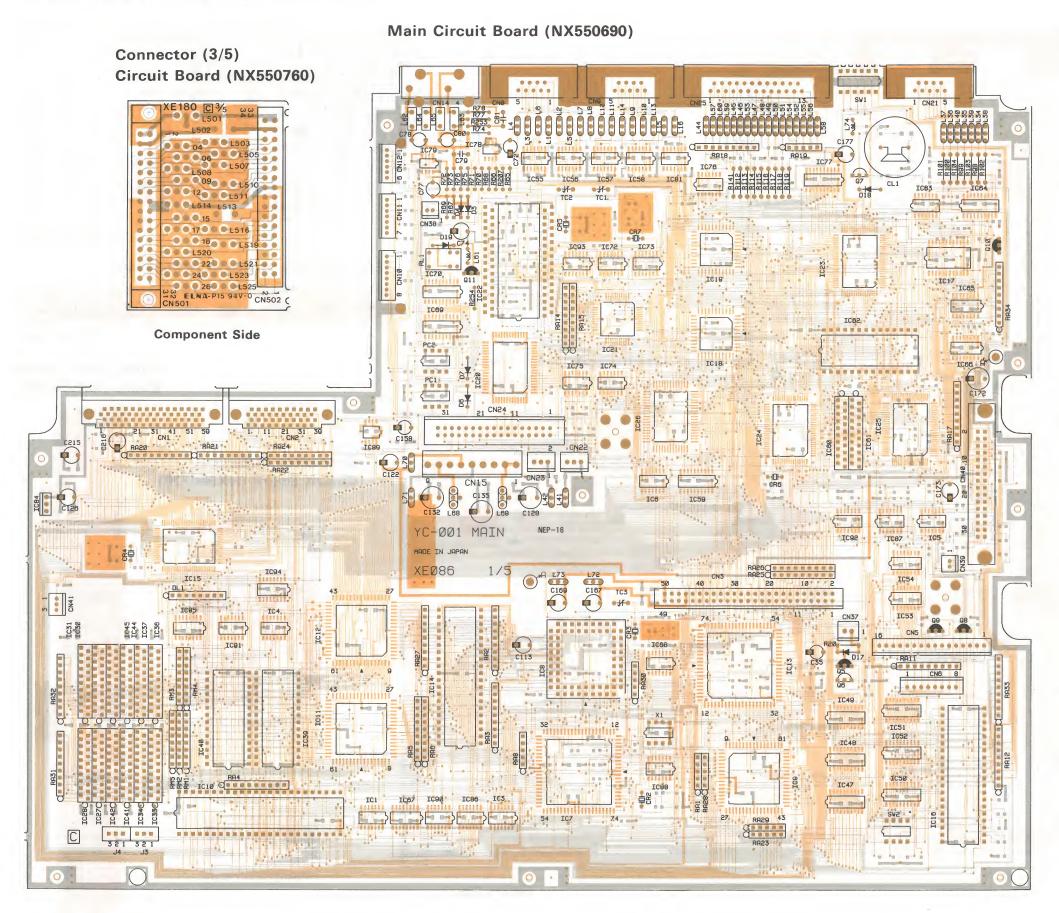
Latch Removal

- 1. Remove the LCD unit. (See LCD Unit Removal.)
- 2. Remove the screw for the shield plate to be removed.
- 3. Bend the latch toward you fully, then slide it for removal.

MEMO

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■ PRINTED CIRCUIT BOARDS

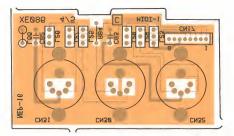


Power LED (5/5) Circuit Board (NX550780)



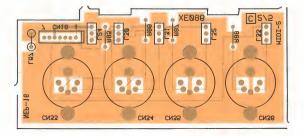
Component Side

MIDI-1 Circuit Board (NX550700)



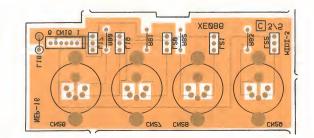
Pattern Side

MIDI-2 Circuit Board (NX550710)



Pattern Side

MIDI-3 Circuit Board (NX550720)



Pattern Side

Main Circuit Board (NX550690) Inverter Circuit Board (NX550790) XEI8I Component Side LED (1/5) Circuit Board (NX550740) 00000000 8 R30 Pattern Side Slider (2/5) Circuit Board (NX550750) 0000 Connector (4/5) Circuit Board (NX550770) **Component Side** LCD Circuit Board (NX550730) NEP -16

Pattern Side

Component Side

MUSIC COMPUTER



PARTS LIST

ELECTRICAL PARTS

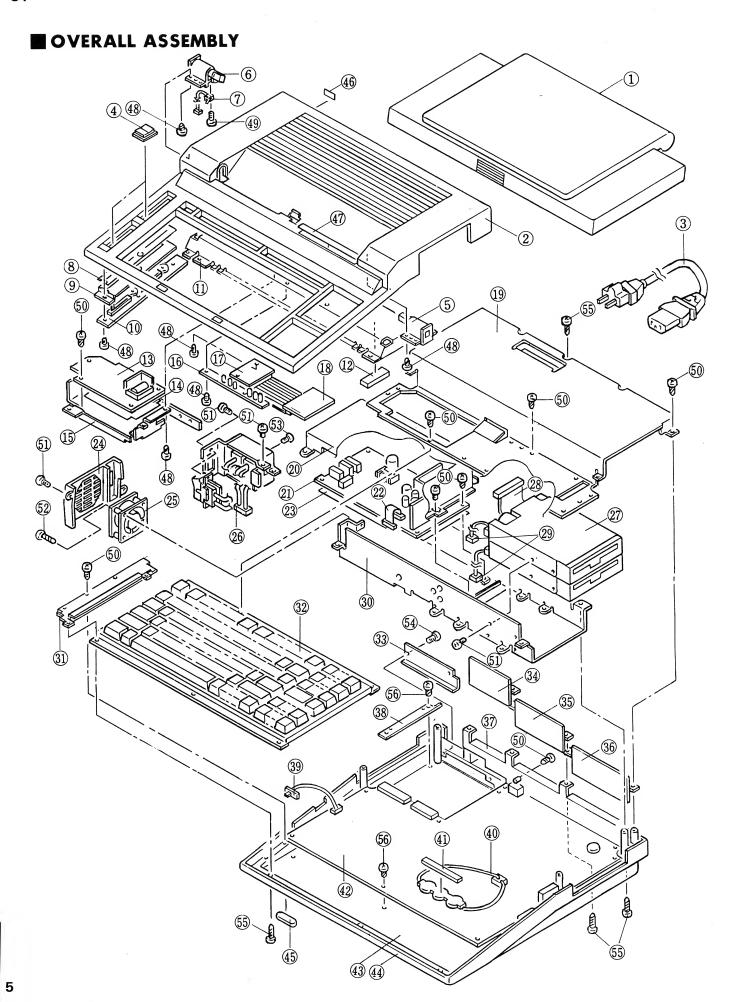
Ref Part	No	Description		部品名	Remarks	ラン
NX550	690 Circuit 700 Circuit 710 Circuit	t Board	MAIN MIDI-1 MIDI-2	メインシート M I D I - 1 シート M I D I - 2 シート		91 16 16
NX550	720 Circuit	t Board	M I D I - 3	M I D I - 3シート		16
	<u>730 Circuit</u> 740 Circuit		LCD LED(1/5)	<u> </u>		12
	750 Circuit		SLIDER (2/5)	スライダーシート		16
	760 Circuit 770 Circuit		CONNECTOR (3/5)		,	13
N X 5 5 0	780 Circuit	t Board	POWER LED(5/5)	POWER LEDシート		0.9
N X 5 5 0	790 Circuit	t Board	INVERTER	インバータシート		16
IG103	520 IC A00 IC		NJM4558MT-1 TL7705CPS-B-R	I C	OP AMP.	03
XE068			AN79N09	I C	SOP REGULATOR -9V	
XE444			UPC311G-TP1	I C	COMPARATOR	
XD238 XD355	001 IC A00 IC		TC74HC244F-TP1 HD74LS125AFPTL		BUF	0.4
XD600	AOO IC		TC74HC02F-T1	I C	NOR	02
	A00 IC A00 IC		TC74HC14F-T1 SN74LS541NS	I C	SOP SOP	0 4
XD830			SN74HCO4NSR	I C	INV	01
	AOO IC		TC74HC393F-T1	I C	SOP	
	A00 IC A00 IC		TC4069UBF-T1 TC50H001F-T1	I C	INV BUFF	
	AOO IC		SN74ALS245ANSR		BUF	1
	AOO IC		SN74ALS273NSR	I C	F-F	
	A00 IC A00 IC		SN74ALS573NSR SN74ALS1005NSR	I C	LAT	
	AOO IC		HD74LS145FP-TL		DEC	
	AOO IC		74F00SJ-TP	I C	NAND	
	A00 IC A00 IC		74F112SJ-TP HD74LS02FP-TL	I C	JK-FF NOR	
	AOO IC		SN74ALS153NSR	İČ	SELECTOR	
	AOO IC		SN74HC54ONSR	I C	BUFF	
	400 IC 400 IC		SN74LS30NSR SN75188NSR	I C	DRIVER	
XE540	AOO IC		SN75189ANSR	I C	RECEIVER	
	AOO IC		TC40H000F-TP1	I C	NAND	
	400 IC 400 IC	1	SN74LS08NSR SN74ALS139NSR	I C	AND DEC	+
	AOO IC		TMP82C55AF-10	I C	PPI	0.6
	400 IC 400 IC		CF77258FT UPD65013GF-394	- I C	MIDI CONTROL YCA	
	AOO IC		UPD65024GF-064		YCAD	
	AOO IC		UPD65012GF-288		YCAP	1
	100 IC 100 IC		V6366B-F YM610 HD63265P	2 I C I C	PCDC FDC	
XE083	AOO IC		MB8042	I C	KBC	
	300 IC		UPD78C11G-158-		SUB CPU	
	400 IC		TMP82C54M-2 WD16C450JM-00	I C I C	TIMER GENERATOR	
	AOO IC		P82C201-10	I C	SYS CONTROLLER	
	100 IC		P82C202 P82A203	I C	I/O CONTROLLER ADDRESS BUS	
	00 10		P82A204	I C	ADDRESS BUS	+
_	00 IC		P82A205	I C	PARITY GEN	
	100 IC		P82C206 M5M4464AL-10	I C	PERIPHERAL CONT	
	00 10		M5M4464AL-12	I C	DRAM 256K	
	00 IC		MB81C425612PSZ		1 M	
	100 IC 300 Photo C	Coupler	MB81C425610PSZ PC910	I C フォトカプラ	1 M	0.6
IA093	360 Transis	tor	2SA933S R	トランジスタ		100
	300 Transis 070 Transis		2SB1068 K, U	トランジスタ		1.
	580 Transis		2SC1740S R,S 2SC1815 Y,GR	トランジスタトランジスタ		01
IF003	150 Diode		188133	ダイオード		0.1
	270 Carbon 170 Carbon		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	カーボン抵抗カーボン抵抗		01
HF855	50 Carbon	Resistor	$\frac{47.0 \Omega}{150.0 \Omega} \frac{176W}{J}$	カーボン抵抗		01
HF855	80 Carbon	Resistor	180.0Ω 1/6W J	カーボン抵抗		0.1
	220 Carbon 170 Carbon		220.0Ω 1/6W J 470.0Ω 1/6W J			01
HF856	220 Carbon	Resistor	$\frac{470.0 \Omega}{2.2 \text{K} \Omega} \frac{176 \text{W}}{16 \text{W}} \text{J}$	カーボン抵抗 カーボン抵抗		01
HF856	70 Carbon	Resistor	2.7KΩ 1/6W J	カーボン抵抗		0.1
HF856	330 Carbon 170 Carbon	Kesistor	$egin{array}{cccccccccccccccccccccccccccccccccccc$	カーボン抵抗カーボン抵抗		01
111.030	00 Carbon	VE212 COL	10.0KΩ 1/6W J	カーボン抵抗	1	01

HF857470 VD307000 VD308500 VD309000 VD309700 VD309900	Carbon Resistor Carbon Resistor Chip Resistor	22.0KΩ 1/6W J 47.0KΩ 1/6W J	カーボン抵抗カーボン抵抗		01
HF857470 VD307000 VD308500 VD309000 VD309700 VD309900	Carbon Resistor Chip Resistor		カーゼン抵抗		
VD307000 VD308500 VD309000 VD309700 VD309900	Chip Resistor				01
VD309000 VD309700 VD309900	Chi- Di-+on	10.0Ω 1/10W J	チップ抵抗		
VD309700 VD309900		33.0Ω 1/10W J	チップ抵抗チップ抵抗		
VD309900	Chip Resistor	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	チップ抵抗		_
VD309900	Chip Resistor	120.0Ω 1/10W J	チップ抵抗		
	Chip Resistor	180.0Ω 1/10W J	チップ抵抗		
	Chip Resistor	220.0Ω 1/10W J	チップ抵抗		
VD311000	Chip Resistor	330.0Ω 1/10W J	チップ抵抗		
VD311500	Chip Resistor	470.0Ω 0.1W J 1KΩ 1/10W J	チップ抵抗チップ抵抗		
	Chip Resistor	2.2KΩ 1/10W J	チップ抵抗		
	Chip Resistor Chip Resistor	4.7KΩ 1/10W J	チップ抵抗		
VD314700	Chip Resistor	10.0KΩ 1/10W J	チップ抵抗		
	Chip Resistor	22.0KΩ 1/10W J	チップ抵抗		
		470.0KΩ 1/10W	チップ抵抗		
		1MΩ 1/10W J			
VF502000	Chip Resistor	10MΩ 1/10W J			02
HZ004730	Resistor Array				01
					01
			抵抗アレイ		01
		RMLS8-472J	抵抗アレイ		0.1
		RMLA4-330J	抵抗アレイ		02
					01
VD455600	Chip Monolithic Cera, Cap.				
VD499100	Chip Monolithic Cera. Cap.	47PF 50V J	チップ積層セラコン		
	Chip Monolithic Cera. Cap.	2200PF 50V K			
VD914700	Chip Monolithic Cera. Cap.	4700PF 50V K	チップ積層セラコン		0 1
VE345200	Chip Monolithic Cera. Cap.		ナップ順暦セプコン		
VE788700	Chip Monolithic Cera. Cap.				1
VD450000	Chip Monolithic Cera. Cap.	0.01 μ F 50V K	チップ積層セラコン		01
VD915300	Chip Monolithic Cera. Cap.				01
VE790000	Chip Monolithic Cera. Cap.	0.047 μ F 50 Z			01
					01
					01
					0.1
		4.7μ F 50.0V M	ケミコン		01
		10.0 μ F 16.0 V Μ	ケミコン		01
		47.0 μ F 25.0 V M	グミコン B D ケミコン		01
					0.2
		HFN-0071	EMIコイル		02
VF228000	Coil	EL0909RR-473K			
				100 μ π	
			EMIフィルター		
		32.768KHZ	水晶振動子		0 4
VC048500	Quartz Crystal Unit	20M EXO-3C	水晶振動子		1
VD567000	Quartz Crystal Unit	3.83616M NR-18	水晶振動子		0.4
VE804700	Quartz Crystal Unit				_
VE804800	Quartz Crystal Unit Quartz Crystal Unit		水晶振動子		
		51D-0401	スライドSW		0.3
VF179100	Dip Switch	DISP6B-1		uu/D!	
VF307000	Pin Jack		E	WII/DL	+
			I C Y ケット		
			ICソケット		
		DC AG40199	リレー		100
GE300670	Ferrite Bead	BLO2RN2 R62T2	フェライトビーズ		02
VE439400	Ferrite Bead	DSS310-55D223S			
			, L	16P	
		9150-4500SC	コネクタ	5 0 P	
		50MIL 1.27 SE	コネクタ	4 0 P	08
VE474700	Connector	50MIL 1.27 SE			0.8
			コネクタ		
				16P	
	VD316300 VD316400 VD317200 VD319100 VD319900 VF502000 HZ004730 VA822600 VB594000 VE742900 FA154100 FG213100 VD499100 VD455600 VD499100 VD455600 VD499100 VD455600 VD499100 VD455600 VD499100 VD455600 VD499100 VD455600 VD4915100 VD914300 VE788700 VD914300 VE788700 VD914700 UJ147470 UJ137100 UJ137100 UJ157470 UJ166470 UJ137100 UJ157470 UJ166470 UJ148100 UJ137100 UJ157470 UJ166470 UJ148100 UJ157470 UJ166470 UJ148100 UJ157470 UJ166470 UJ166470 UJ179100 VF280400 VF280400 VF280400 VF606600 VF606600 VF606600 VF804600 VE804800 VE804800 VE804900 VF371100 VF307000 VF3771100 VF307000 VF3771100 VF307000 VF3485900 VF284800 VE804800 VE804800 VE804900 VF3771100 VF823900 VF24874700 VF24874700 VF2750000 VE7750000	VD316300 Chip Resistor VD316400 Chip Resistor VD317200 Chip Resistor VD319100 Chip Resistor VD319900 Chip Resistor VF502000 Resistor Array VA092200 Resistor Array VB350600 Resistor Array VB594000 Resistor Array VE742900 Resistor Array VE742900 Resistor Array VE742900 Resistor Array VE742900 Chip Monolithic Cera. Cap. VD495600 Chip Monolithic Cera. Cap. VD499100 Chip Monolithic Cera. Cap. VD499200 Chip Monolithic Cera. Cap. VD499200 Chip Monolithic Cera. Cap. VD4914300 Chip Monolithic Cera. Cap. VD914700 Chip Monolithic Cera. Cap. VD915300 Chip Monolithic Cera. Cap.	ND316300	VAD 310 300	### ### ### ### ### ### ### ### ### ##

Ref	Part No	Description		部 品 名	Remarks	ラン
	VE753000 VE753100 VF551300 VE744400 LB918020 LB918030 UB932090 VB389900 VB390200 VB390400	Connector D-SUB Connector D-SUB Connector D-SUB Connector DIN Connector Connector Base Connector Base KR Connector KR Connector KR Connector KR Connector KR Connector	PCN10H- 17LE-13090- 17LE-23090- 17LE-13250- TCS0845-01-2051 XH 2P TE XH 3P TE VH 9P TE KR,PH 3P TE KR,PH 6P TE KR,PH 6P TE KR,PH 7P TE KR,PH 8P TE UAMS-07-0	ベースフォオスト ベーーススポネト KRコネネクタ KRコネネクタ KRコララフタ	32P2.54DSA 28D4CK 28D4CK 28D4CK 5P	01 01 01
	VE743700 VE743800 VE743900 VE744200 VF516000 VF443100 VF443200	Delay Line MIDI Cable MIDI Cable MIDI Cable Cable Cable Holder	PKM22EPP-4001 500C62ES 8P 7P 6P 12V × 3 MIDI Board × 4 MIDI Board	 スディーカーフ東東東ーーフ東東東ーーフ東東東ーース I D J I パパ金金 リン・マン N 金金 リカース カーリーフ東東東 R 線線線線線線線線線線線 カーリース カーリース 		0.4
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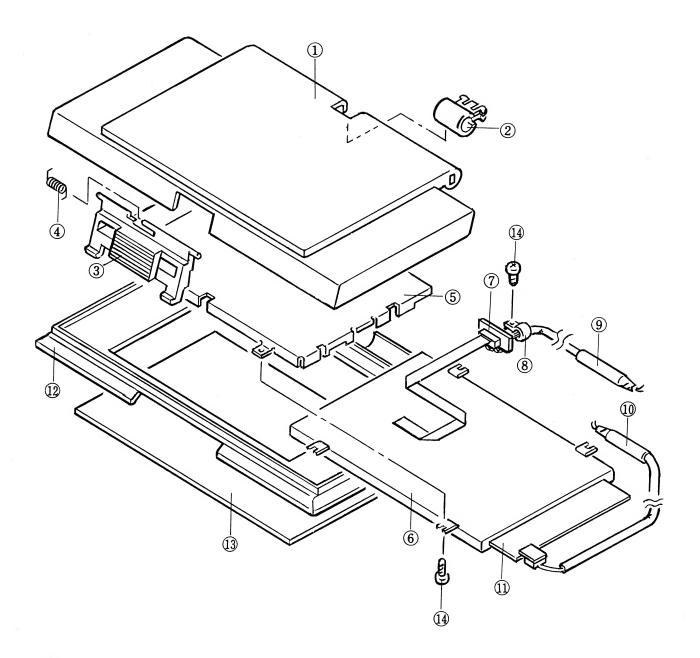
POWER SUPPLY UNIT

ef Par	t No	Description		部 品 名	Remarks	ランケ
VF67	1200 F	Power Supply Unit		電源ユニット		30
1 X 8 0	3640	10	MB3759	I C		
IXOO	0910	C	TL431CLPB	I C		03
	2001		AN79M12F AN79M24F	I C I C		03
	3650 1 0480 F	Photo Coupler	PC817 5KV	フォトカプラ		0.3
IX80	3660	Transistor	2SA1451	トランジスター		
		Transistor	2SC1815 Y	トランジスター		03
		Transistor MOS FET	2SC1959 Y 2SK724	トランジスター MOS FET		103
	3680		DIOSCOM	ダイオード		
	3690		ESAB92M-02	ダイオード		
	3700 [3710 [ESAB82M-004 ERB38-06	ダイオード ダイオード	*	
	1230 I		ERB44-04	ダイオード		03
IX80	2720)iode	1SS178 0.1A 80V			01
		Zener Diode	RD6.2EB2	ツェナーダイオード ツェナーダイオード		01
	-	Zener Diode Zener Diode	RD13EB3 RD10EB2	ツェナーダイオート		01
		Zener Diode	RD5.1EB2	ツェナーダイオード		01
IX80	3720 2	Zener Diode	RD3.3E	ツェナーダイオード		, ,
		Zener Diode	RD39EB1 D3SB40	ツェナーダイオード ダイオードスタック		01
		Diode Stack Carbon Film Resistor	100Ω 1/6W	カーボン抵抗		01
		Carbon Film Resistor	220Ω 1/6W	カーボン抵抗		01
		Carbon Film Resistor	1KΩ 1/6W	カーボン抵抗		01
		Carbon Film Resistor Carbon Film Resistor	2.2KΩ 1/6W 2.7KΩ 1/6W	カーボン抵抗 カーボン抵抗		01
HF85	7100 0	Carbon Film Resistor	10KΩ 1/6W	カーボン抵抗		0 1
HF85	7220 (Carbon Film Resistor	22KΩ 1/6W	カーボン抵抗		01
		Carbon Film Resistor Carbon Film Resistor	470Ω 1/6W 4.7KΩ 1/6W	カーボン抵抗 カーボン抵抗		01
		Carbon Film Resistor	27KΩ 1/6W	カーボン抵抗		01
HF85	8100 (Carbon Film Resistor	100KΩ 1/6W	カーポン抵抗		01
		Carbon Film Resistor	68KΩ 1/6W	カーボン抵抗 セメント抵抗		01
		Vire Wound Resistor Vire Wound Resistor	0.33Ω 5W 0.02Ω 5W	セメント抵抗		02
		Metal Oxide Film Resistor	22Ω 1W	酸化金属皮膜抵抗		01
HL31	4470	letal Oxide Film Resistor	47Ω 1W	酸化金属皮膜抵抗		01
		Metal Oxide Film Resistor Metal Oxide Film Resistor	10Ω 2W 47Ω 2W	酸 化 金 属 皮 膜 抵 抗 酸 化 金 属 皮 膜 抵 抗		01
		Metal Oxide Film Resistor	1 K Ω 2 W	酸 化 金 属 皮 膜 抵 抗		01
HL32	7270	letal Oxide Film Resistor	27KΩ 2W	酸 化 金 属 皮 膜 抵 抗		01
		(etal Oxide Film Resistor) (etal Oxide Film Resistor)	47KΩ 2W 47KΩ 3W	酸 化 金 属 皮 膜 抵 抗		01
		Tuse Resistor	10Ω 2W	ヒューズ抵抗		
HX80	4080 I	Tuse Resistor	100Ω 1/6W	ヒューズ抵抗		
		Frimmer Pot.	B1 K Ω 560 μ F 200 V	半固定ポリュームケミコン		
		Electrolytic Cap. Electrolytic Cap.	4700 μ F 16 V	ケミコン		05
		Electrolytic Cap.	1000 μ F 16 V	ケミコン		02
FX55	C640 1	Electrolytic Cap.	330 μ F 50 V	ケミコン		03
		Electrolytic Cap. Electrolytic Cap.	22 μ F 35 V 3300 μ F 10 V M	ケミコンケミコン		03
		Electrolytic Cap.	0.47 μ F 50V	ケミコン		01
FJ26	6330 I	Electrolytic Cap.	3.3 μ F 50 V	ケミコン		01
		Electrolytic Cap.	1 μ F 50 V	ケミコン スチコン		01
		Polystyrene Cap. Polystyrene Cap.	1000PF 50V J 22000PF 50V J	スチョンスチョン		02
		Polystyrene Cap.	47000PF 50V J	スチコン		02
FD15	4150 F	Polystyrene Cap.	15000PF 50V J	スチコン		02
		Polystyrene Cap.	0.18 μ F 250V	スチコン スチコン		
		Polystyrene Cap. Ceramic Cap.	0.22 μ F 250V 100PF 2KV	スチョン セラコン		
		Ceramic Cap.	330PF 2KV	セラコン		
F I 38	3220 0	Ceramic Cap.	0.0022 μ F 125V	セラコン		01
		Ceramic Cap.	0.01 μ F 125 V SU16 V - 12035	セラコン コイル		01
	1410 0		C-L00-174-11	コイル		
G X 8 C	1430	Coil	L-10001-11	コイル		-
	1210		TSC 5A 125V	ヒューズ コネクタ		01
		Connector Connector	5096-02C 89P- V H	コネクタ		01
[, X80	1520	Connector	B 3 B - X H - A	コネクタ		
1 X 8 C	3740	Thyristor	CRO2AM	サイリスタ		
		Thermistor Transformer	8D-18 N-T00-305-11	サーミスター 電源トランス		
11110	1440	ri angrormet	" 100 909-11	es Wh I / / A		



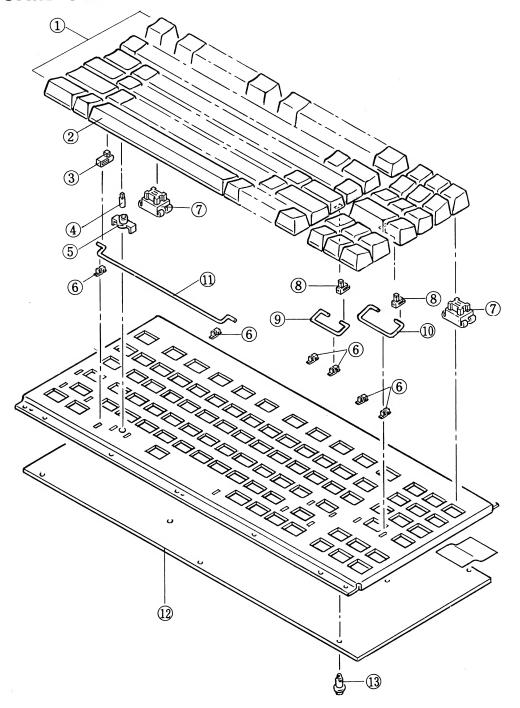
Ref	Part No	Description		部 品 名	Remarks	ランク
1		Panel Assembly		パネルASS'Y 上ケース		16
2 3		Upper Case Power Cord		エクース 電源ケーブル		
4	VB774000	Knob		ツマミ		01
5		Hinge Unit Hinge Unit	Right Left	_ ヒンジユニット(右) _ ヒンジユニット(左)		_
7	VF638000	Micro Switch Assembly	2010	マイクロスイッチAss'y		
8		Dust Proof Cloth		防 塵 ク ロ ス ス ラ イ ダ 上 シ ー ル ド		
9	NX550750	Slider Upper Shield Circuit Board	SLIDER(2/5)	スライダシート		16
11	VF443400	Upper Shield	CAAO DI	上シールド ACTパッド		
12	VC920900	ACT Pad Circuit Board	C440 BL INVERTER	インバータシート		16
14	VF574300	Insulation Sheet		INV絶縁シート		
15	VF522000	Angle Bracket Circuit Board	LED(1/5)	<u>インバータ金具</u> LEDシート		12
17		Circuit Board	CONNECTOR (4/5)	変換シート		13
18		Circuit Board Internal Shield	CONNECTOR (3/5)	中継シート 中シールド		13
19	VF444100	Power Supply Cover	-	電源カバー		- 0.0
21	VF671200	Power Supply Unit	100-120V	電源 ユニット 電源 束 線		30
22	VF596500	Power Cable Insulation Sheet		絶縁シート		
24	VF495500	Vent		ファンカバー		
25	VF438200	Cooling Fan Assembly AC Socket Assembly		ファンAss'y ACインレットAss'y		
27	VG192800	3.5" Floppy Disk Drive	ND-352S-A 02	3.5 4 V F F D D	C1 /20	31
: 27	VG315200	3.5" Hard Disk Drive	HDD CONTROLLER	3.5インチHDD コントローラーシート	C1/20 C1/20	
27 - 1 27 - 2		Circuit Board HDD Cable	HDD CONTROLLER	HDケーブル	C1/20	
: 27-3	VG175000	HDD Cover		H D D カバー F D D 信 号 束 線	C1/20	
* 28 * 29	VF598100	FDD Signal Cable FDD Power Cable		FDD電源東線	0(1	
∤ 30	VF444000	Mid Frame		ミッドフレーム		
31 32	VF443900	Slider Lower Shield Keyboard Unit		スライダ下シールド キーボードユニット		17
33		Slot Cover		スロットカバー		16
34		Circuit Board	MIDI-1 MIDI-2	M I D I - 1 シート M I D I - 2 シート		16
35 36		Circuit Board Circuit Board	MIDI-3	M I D I - 3シート		16
≭ 37	VF443700	Angle Bracket		コネクタ金具 ガイドプレート		
* 38 39		Guide Plate Circuit Board	POWER LED(5/5)	POWER LEDシート		0.9
# 40	VF404000	Ni-Cd Battery Assembly	C440 10X50 T=4	Ni - Cd電池 Ass'y 電池パッド		
* 41 42	NX550690	Battery Pad Circuit Board	MAIN	メインシート		91
4 4 3	VF443600	Lower Sheild		下 シールド 下 ケース	C 1	17
4 4 * 4 4		Lower Case Lower Case		下ケース	C1/20	
45	CB055690		BL	ゴム足		01
* 46	VF647000		120 V LED	120Vラベル LEDラベル		
* 47 48	VF671100	Bind Head Tapping Screw	3.0X10 ZMC2Y	n " イント " タッヒ ° ンク " ネシ "		01
49	E 1020106	Bind Head Tapping Screw	2.0X10 ZMC2Y 3.0X8 FNM33G	Λ * イント * タッヒ ° ンク * ネシ * Λ * イント * タッヒ ° ンク * ネシ *		01
50	E1130086	Bind Head Tapping Screw Bind Head Screw	3.0X6 FCM3BL	バインド小ネジ		01
52	E I 3 3 0 2 0 6	Bind Head Tapping Screw	3.0X20 FCM3BL	n*イント * タッヒ * ソク * ネシ * バインド小ネジ		01
53 54	ED340086	Bind Head Screw Bind Head Screw	4.0X8 FCM3BL 3.0X6 FNM33G	バインド小ネジ		0 1
55	E I 3 3 0 1 4 6	Bind Head Tapping Screw	3.0X14 ZMC2BL	ハ ** イント ** タッヒ ** ソク ** ネシ **		01
56	EK093020	Bind Head Tapping Screw	3.0X8 ZMC2Y	N " イント " タッヒ " ソク " ネジ		01
-	-					
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					- 54	

PANEL ASSEMBLY



*		Description		部品名	Remarks	ランク
	VF670400	Panel Assembly		パネルASS 'Y		
* _ 3	2 VF574400 3 VF572900	Panel Case Cable Guide Panel Hook		パネル外ケース ケーブルガイド パネルフック		14
* 5 6 7 * 8	5 VF443300 6 VF475700 7 NX550730 8 VF573800	Lock Spring Panel Shield LCD Unit Circuit Board Cable Clamp	L M 6 4 0 3 5 U L C D	ロックスプリング パネルシールド LCDシニット LCDシーランプ	640 × 400	6 4 0 7
* 9 * 10 11 12 13 14	0 VF375900 1 VF475800 2 VF572800 3 VF573400	EL Lamp Panel Case Display Panel	2P NEL-5LL-333-W	L C D ケーブル E L ケーブル E L ランプ パネル内 ケース ディスプレイパネル バインドタッピングネジ	-	23 09 15 01

KEYBOARD UNIT



Ref	Part No	Description		部 品 名	Remarks	ランク
	VF296700	Keyboard Unit		キーボードユニット	KFNBBA010D	17
1 2	YX303520 YX303530	Key Top Set	for Spase Bar	キートップセット スペースバーキートップ	J1AAA0931	
3	YX303570	Bracket,B	for Spase	スヘ°~スキーフ゛ラケット	69AAA0018	
4 * 5		Key Top Guide Pin Key Guide	for Spase for Spase	キートップガイドピン スペースバーガイド	16KF006	02
6		Mounting Plate Swich Actuator	for Torsion Bar	マウンティンク゛フ゜レート スイッチト゛ライフ゛ASS'Y	68AAA0001 L7AAA0002	
8	YX303560	Bracket A		キートップブラケット	69AAA0003	
9		Torsion Bar A Torsion Bar B	Short Long	トーションバー(A) トーションバー(B)	74AAA0004 74AAA0005	
11112		Torsion Bar C A Point Of Contact	for Spase Bar	トーションバー(C) 接点ASS'Y	74AAA0012 54AAA0008	
13	EX550020			特殊ネジ	2D00AA005	02